

As below named inventors, we hereby declare that:

Our residence, post office address and citizenship are as stated below next to our name:

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought in the invention entitled Processing Substrate and/or Support Surface, Serial No. 10/075,020, which was filed on February 12, 2002.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

We hereby claim the benefit, under Title 35, United States Code, § 120, of any United States application(s) or PCT International application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, we acknowledge the duty to disclose information that is material to patentability as defined in 37, Code of Federal Regulations, § 1.56.

defined in 37, Code of		Filed F	Priority Claimed
Country Ap	oln. No.	(Day/Mo/Yr.)	(Yes/No)
		October 2, 2000	Yes
United States 09/677	,663		nited States Code,

We hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

having a filin	Priority Claimed		
Country	Appln. No.	Filed (Day/Mo/Yr.)	(Yes/No)
			: d I Houser

We hereby appoint Richard J. Rodrick (Reg. No. 26,985)), David J. Houser (Reg. No. 29,172), Kristin L. Chapman (Reg. No. 38,102), Robert A. Miller (Reg. No. 26,956), Linda Blair Meier (Reg. No. 39,769) and Frank B. McDonald (Reg. No. 28,738) as our attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith.

COMBINED DECLARATION AND POWER ATTORNEY FOR PATENT APPLICATION

Address all correspondence to:

The Correspondence Address For USPTO Customer No. 28165

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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